

Features

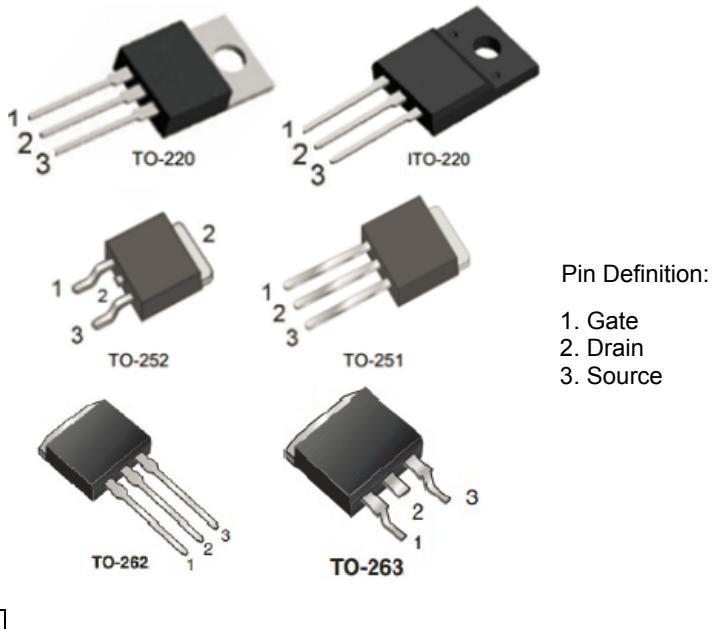
- RDS(ON) < 4.4Ω@ VGS = 10V, ID = 1A
- Fast switching capability
- Lead free in compliance with EU RoHS directive.
- Improved dv/dt capability, high ruggedness

Mechanical Data

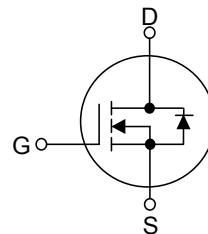
- Case: TO-251, TO-252, TO-220, ITO-220
TO-262, TO-263 Package

Ordering Information

Part No.	Package	Packing
2N60P	TO-251	75pcs / Tube
2N60D	TO-252	75pcs / Tube
2N60T	TO-220	50pcs / Tube
2N60F	ITO-220	50pcs / Tube
2N60K	TO-262	50pcs / Tube
2N60G	TO-263	50pcs / Tube



Block Diagram



Maximum Ratings $T_A = 25^\circ\text{C}$ unless otherwise specified

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V_{DSS}	600	V
Gate-Source Voltage		V_{GSS}	± 30	V
Avalanche Current (Note 2)		I_{AR}	2.0	A
Continuous Drain Current		I_D	2.0	A
Pulsed Drain Current (Note 2)		I_{DM}	8.0	A
Avalanche Energy	Single Pulsed (Note 3)	E_{AS}	115	mJ
Power Dissipation	TO-220/TO-262/TO-263	P_D	44	W
	ITO-220		23	W
	TO-251/TO-252		34	W
Junction Temperature		T_J	+150	°C
Operating Temperature		T_{OPR}	-55 ~ +150	°C
Storage Temperature		T_{STG}	-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating : Pulse width limited by maximum junction temperature

3. L = 30mH, $I_{AS} = 2.7\text{A}$, $V_{DD} = 50\text{V}$, $R_G = 25 \Omega$, Starting $T_J = 25^\circ\text{C}$



THERMAL DATA

PARAMETER		SYMBOL	RATING			UNIT	
Junction to Ambient	TO-220/ITO-220 TO-262/TO-263	θ_{JA}	62.5			°C/W	
	TO-251/ TO-252		110				
Junction to Case	TO-220/ITO-220 TO-262/TO-263	θ_{JC}	2.35			°C/W	
	ITO-220		5.5				
	TO-251/ TO-252		2.9				

ELECTRICAL CHARACTERISTICS ($T_c=25^\circ\text{C}$, unless otherwise specified)

PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{GS} = 0\text{V}, I_D = 250\mu\text{A}$	600				V
Drain-Source Leakage Current	I_{DSS}	$V_{DS} = 600\text{V}, V_{GS} = 0\text{V}$			10		μA
Gate-Source Leakage Current	Forward	I_{GSS}	$V_{GS} = 30\text{V}, V_{DS} = 0\text{V}$			100	nA
	Reverse		$V_{GS} = -30\text{V}, V_{DS} = 0\text{V}$			-100	nA
ON CHARACTERISTICS							
Gate Threshold Voltage	$V_{GS(\text{TH})}$	$V_{DS} = V_{GS}, I_D = 250\mu\text{A}$	2.0		4.0		V
Static Drain-Source On-State Resistance	$R_{DS(\text{ON})}$	$V_{GS} = 10\text{V}, I_D = 1\text{A}$		4	4.4		Ω
DYNAMIC CHARACTERISTICS							
Input Capacitance	C_{ISS}	$V_{DS} = 25\text{V}, V_{GS} = 0\text{V}, f = 1\text{MHz}$		300	-		pF
Output Capacitance	C_{OSS}			45	-		pF
Reverse Transfer Capacitance	C_{RSS}			2	-		pF
SWITCHING CHARACTERISTICS							
Turn-On Delay Time	$t_{D(\text{ON})}$	$V_{DD} = 300\text{V}, I_D = 2\text{A}, R_G = 25\Omega$ (Note 1, 2)		10	-		ns
Turn-On Rise Time	t_R			25	-		ns
Turn-Off Delay Time	$t_{D(\text{OFF})}$			20	-		ns
Turn-Off Fall Time	t_F			25	-		ns
Total Gate Charge	Q_G	$V_{DS} = 480\text{V}, I_D = 2.4\text{A}, V_{GS} = 10\text{V}$ (Note 1, 2)		5.7	-		nC
Gate-Source Charge	Q_{GS}			1.8	-		nC
Gate-Drain Charge	Q_{GD}			2	-		nC
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS							
Drain-Source Diode Forward Voltage	V_{SD}	$V_{GS} = 0\text{V}, I_{SD} = 2.0\text{ A}$			1.4		V
Maximum Continuous Drain-Source Diode Forward Current	I_S				2.0		A
Maximum Pulsed Drain-Source Diode Forward Current	I_{SM}				8.0		A
Reverse Recovery Time	t_{rr}	$V_{GS} = 0\text{V}, I_S = 2\text{A}, dI_F/dt = 100\text{ A}/\mu\text{s}$ (Note 1)		357			ns
Reverse Recovery Charge	Q_{RR}			2			μC

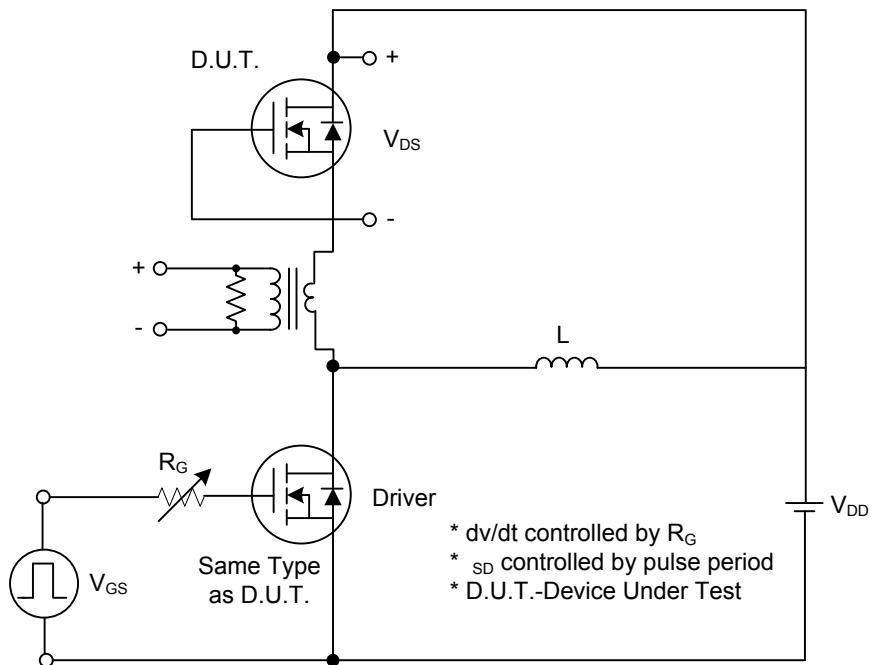
Notes: 1. Pulse Test: Pulse width $\leq 300\mu\text{s}$, Duty cycle $\leq 2\%$

2. Essentially independent of operating temperature

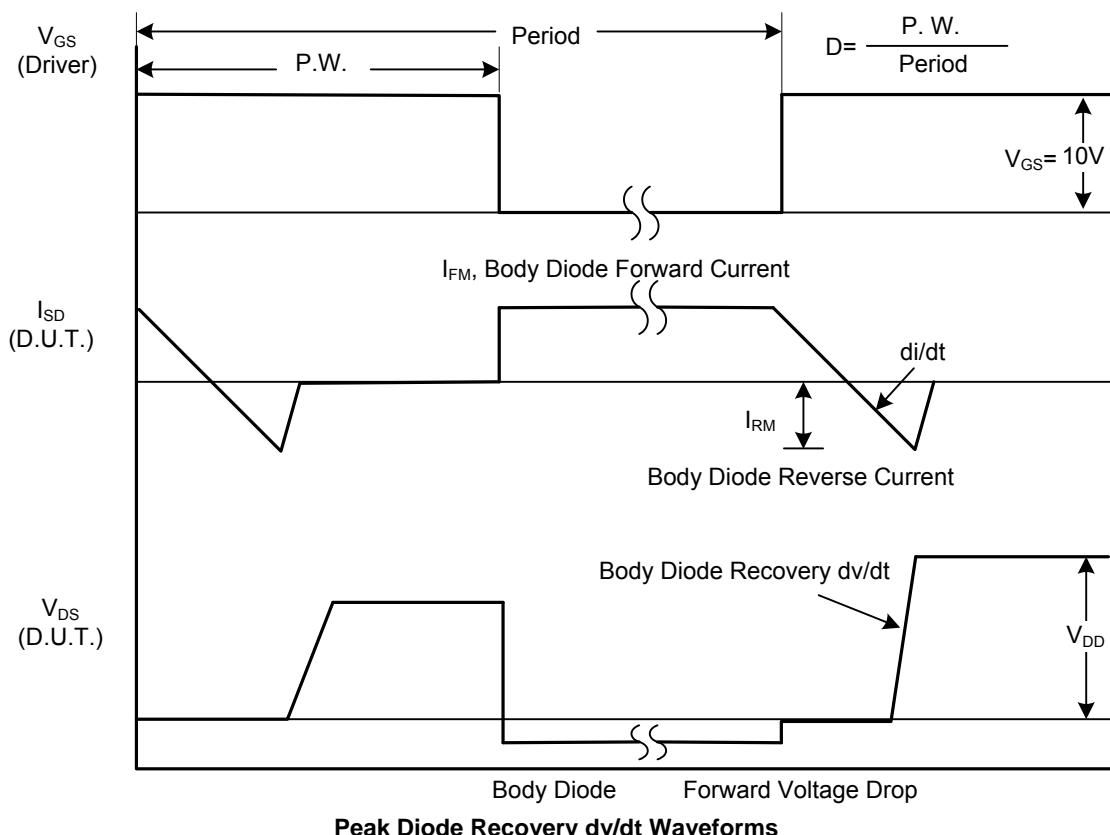


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TEST CIRCUITS AND WAVEFORMS



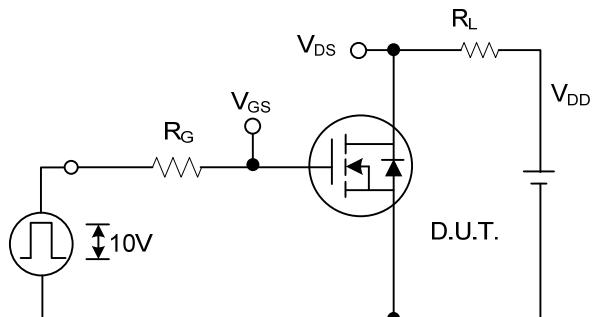
Peak Diode Recovery dv/dt Test Circuit



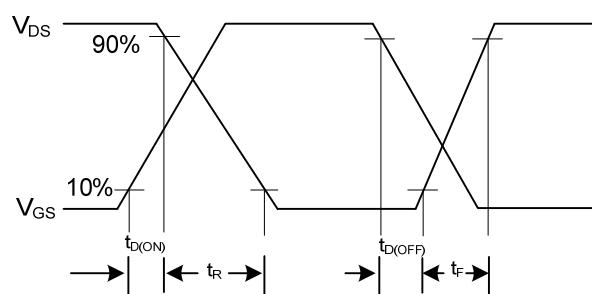


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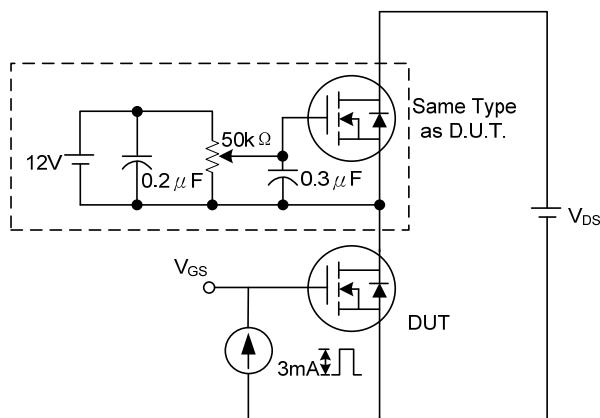
TEST CIRCUITS AND WAVEFORMS(Cont.)



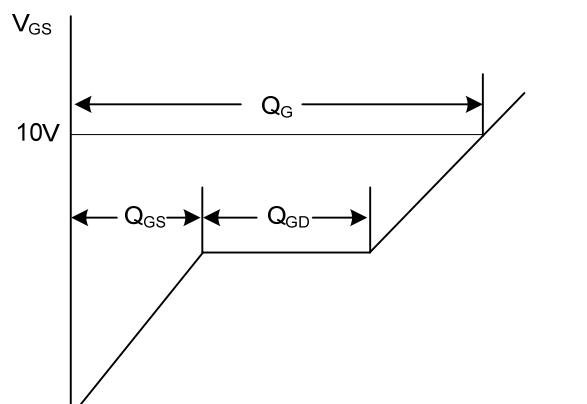
Switching Test Circuit



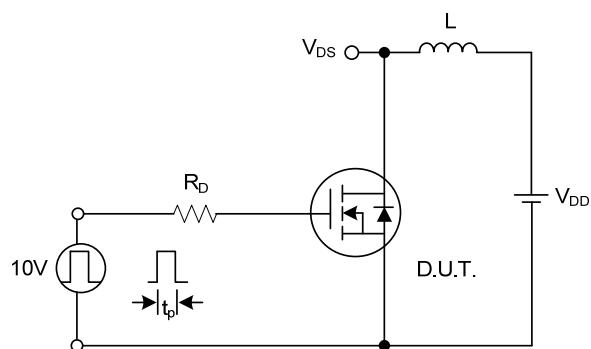
Switching Waveforms



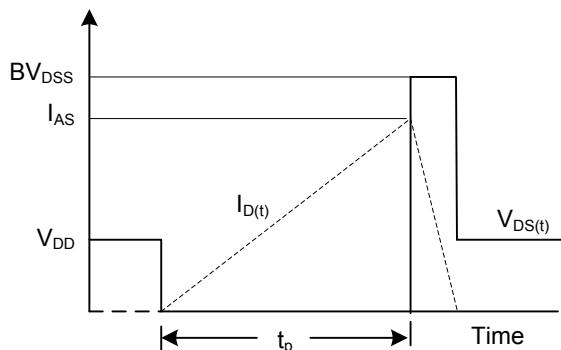
Gate Charge Test Circuit



Gate Charge Waveform



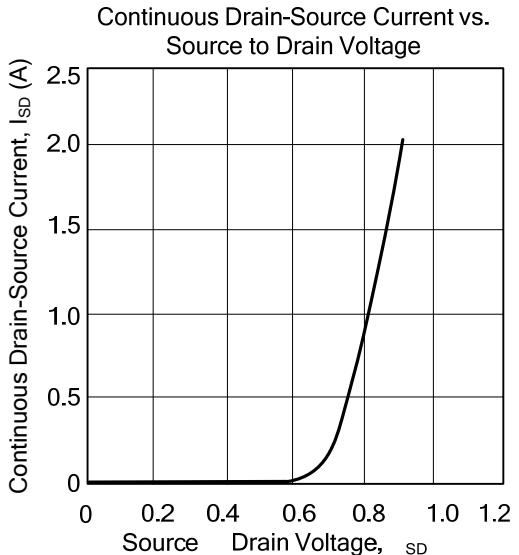
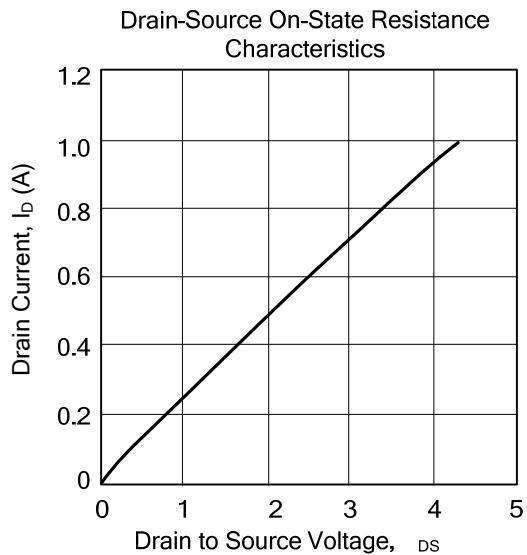
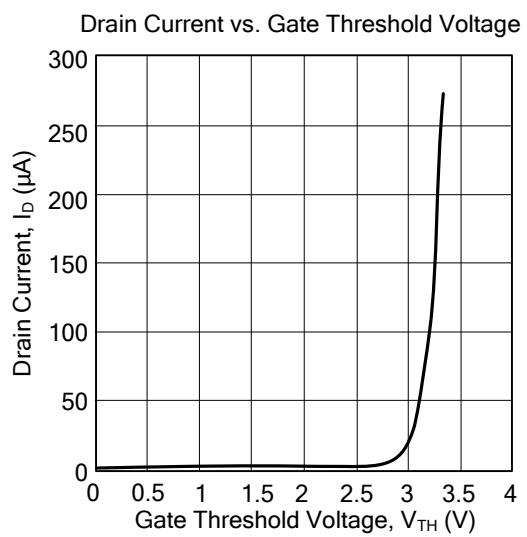
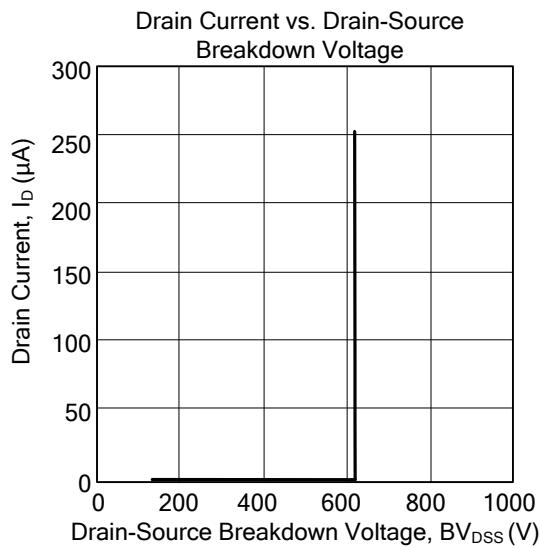
Unclamped Inductive Switching Test Circuit



Unclamped Inductive Switching Waveforms



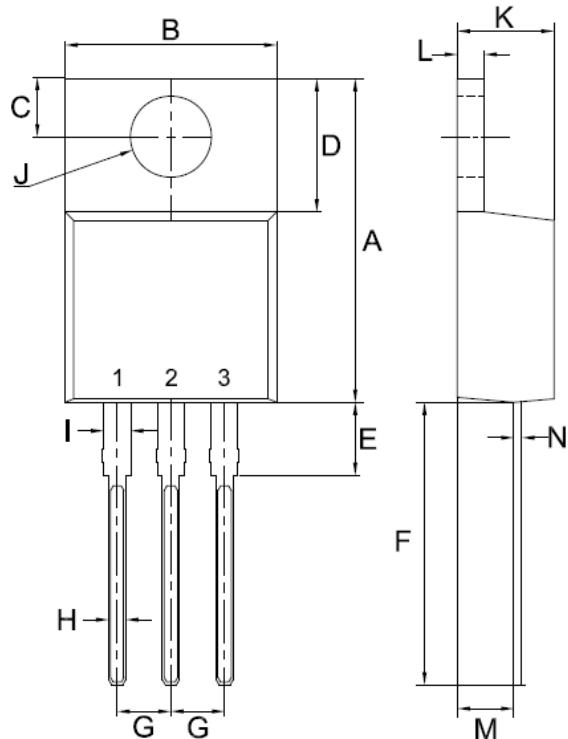
TYPICAL CHARACTERISTICS





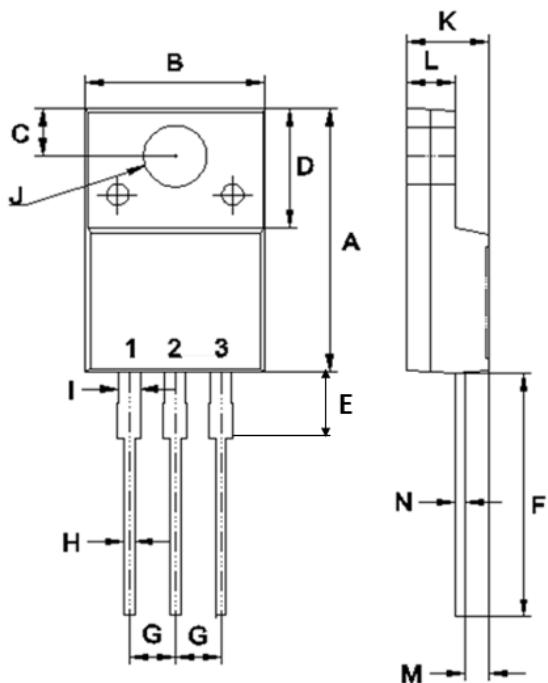
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TO-220 Mechanical Drawing



TO-220AB		
Unit:mm		
DIM	MIN	MAX
A	14.80	15.80
B	9.57	10.57
C	2.54	2.94
D	5.80	6.80
E	2.95	3.95
F	12.70	13.40
G	2.34	2.74
H	0.51	1.11
I	0.97	1.57
J	3.54φ	4.14φ
K	4.27	4.87
L	1.07	1.47
M	2.03	2.92
N	0.30	0.64

ITO-220 Mechanical Drawing

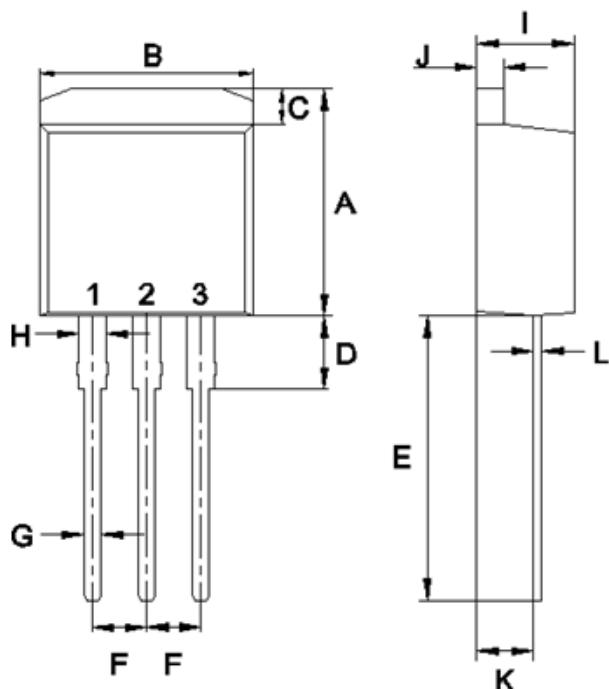


ITO-220AB Unit:mm		
DIM	MIN	MAX
A	14.50	15.50
B	9.50	10.50
C	2.50	2.90
D	6.30	7.30
E	3.30	4.30
F	13.00	14.00
G	2.35	2.75
H	0.30	0.90
I	0.90	1.50
J	3.20	3.80
K	4.24	4.84
L	2.52	2.92
M	1.09	1.49
N	0.47	0.64



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TO-262 Mechanical Drawing

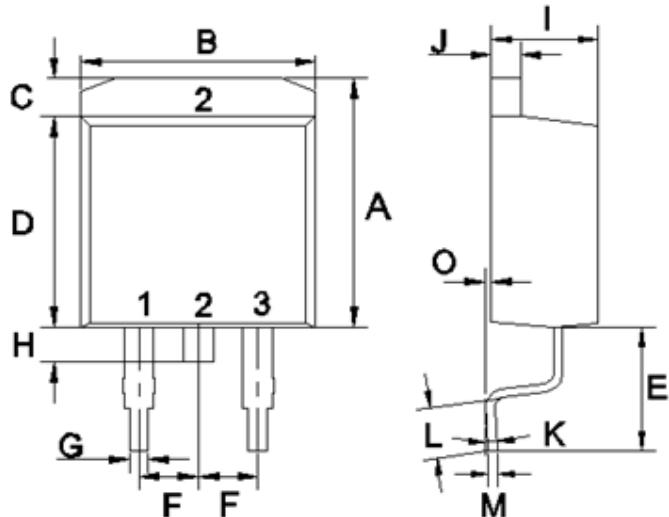


TO-262(I²PAK)

Unit:mm

DIM	MIN	MAX
A	10.14	11.14
B	9.57	10.57
C	1.44	1.84
D	2.95	3.95
E	12.70	13.40
F	2.34	2.74
G	0.51	1.11
H	0.97	1.57
I	4.27	4.87
J	1.07	1.47
K	2.03	2.92
L	0.30	0.46

TO-263 Mechanical Drawing



TO-263(D² PAK)

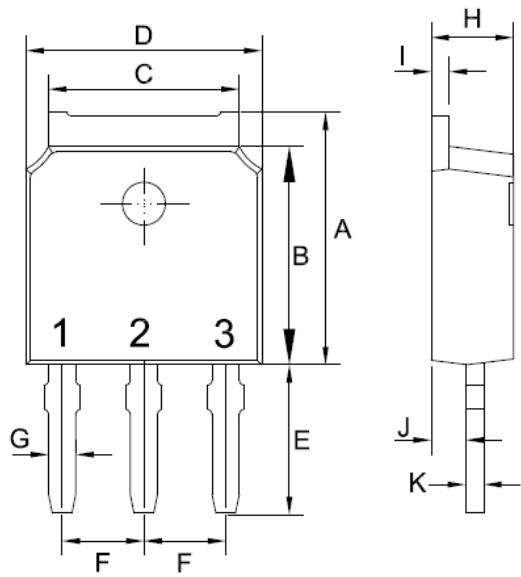
Unit:mm

DIM	MIN	MAX
A	10.44	10.84
B	9.81	10.21
C	1.44	1.84
D	8.80	9.20
E	4.46	4.66
F	2.44	2.64
G	0.61	1.01
H	0.70	1.30
I	4.27	4.87
J	1.07	1.47
K	0°	8°
L	2.10	2.50
M	0.30	0.46
O	0	0.25



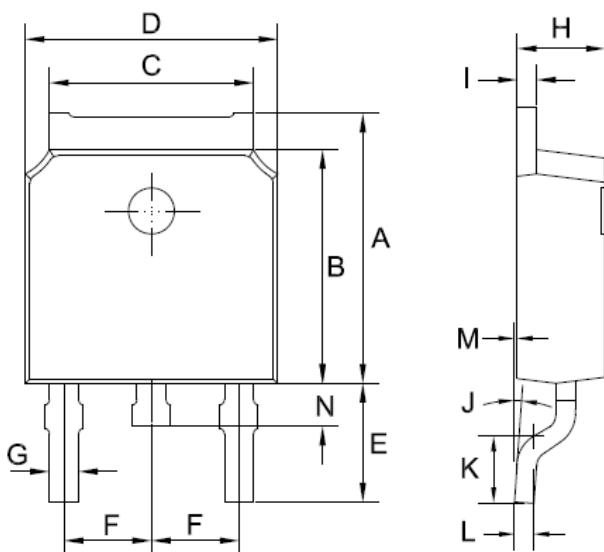
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TO-251 Mechanical Drawing



TO-251 (IPAK)		
Unit:mm		
DIM	MIN	MAX
A	6.85	7.25
B	5.90	6.30
C	5.13	5.53
D	6.40	6.80
E	3.95	4.35
F	2.19	2.39
G	0.45	0.85
H	2.20	2.40
I	0.41	0.61
J	0.71	1.31
K	0.41	0.61

TO-252 Mechanical Drawing



TO-252 (DPAK)		
Unit:mm		
DIM	MIN	MAX
A	6.85	7.25
B	5.90	6.30
C	5.13	5.53
D	6.40	6.80
E	2.90	3.30
F	2.19	2.39
G	0.45	0.85
H	2.20	2.40
I	0.41	0.61
J	0°	8°
K	1.45	1.85
L	0.41	0.61
M	0.00	0.12
N	0.60	1.00